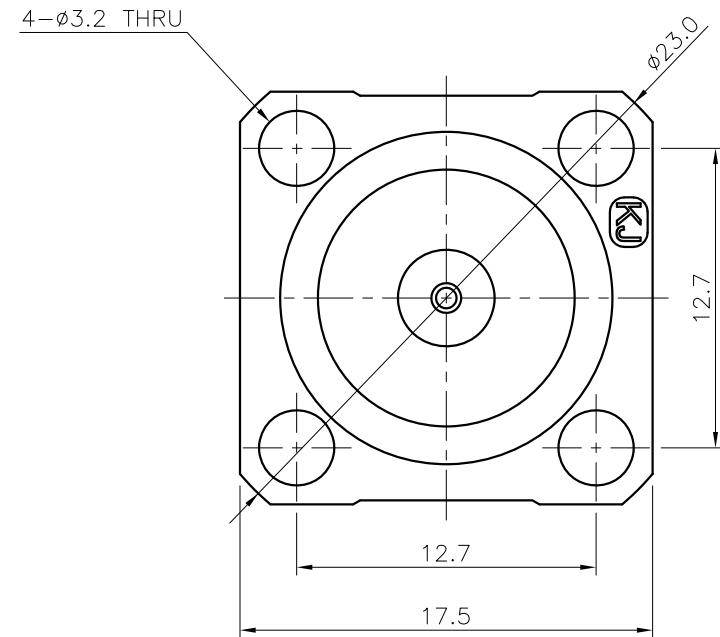
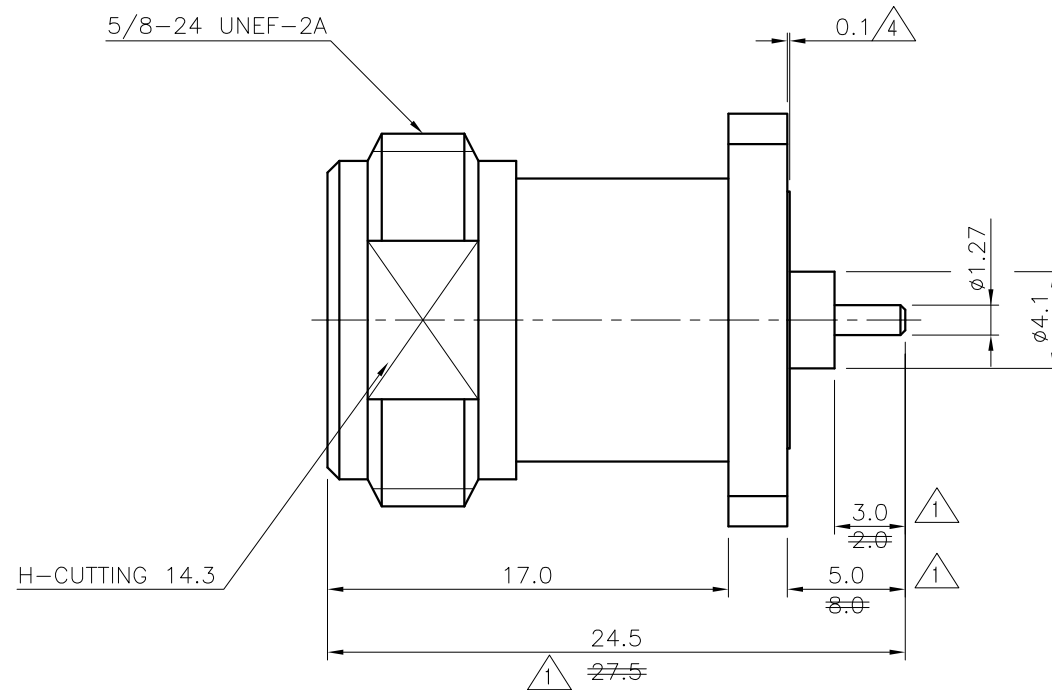


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1R	Initial Registration	C.K.KIM	I.C.KIM	2016.10.10.
1	고객사 요청 절연체 / 핀 길이 변경	I.C.KIM		2016.10.17.
2	[설변처리No.201702-0016] 핀 누시바를 외경 및 위치 수정/도금 진행 개선컨	I.C.KIM		2017.02.23.
3	[설변No.202012-0002] O-RING 빠짐 개선 안착부 금형수정	I.C.KIM		2020.12.07.
4	[설변No.202101-0003] O-RING 빠짐 개선 안착부 0.1mm Ground Boss 추가	S.Y.EUN	I.C.KIM	2021.01.20.
5	RING 억지끼움후 돌출부위 감안하여 길이 조정	S.H.KIM		2024.11.08.



5	4	3	4	RING	1	MBsBD C3604BD-F	Nickel Plate	DSR01097-5/4 DSR01097-5/3
	1		3	INSULATOR	1	TEFLON		DIN02840-N/2
2	1		2	CONTACT	1	BeCu C17300	Gold Plate	DCT03768-5/2
	3		1	BODY	1	ZnDC	Nickel Plate (3~4μm)	DBD02992-5/3 DBD02992-5/1
			NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 11. 08.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____	CHECKED BY				TITLE N50 SOLDER END JS-4H
	DRAWN BY	S.H.KIM			
FINISH _____	SCALE 3/1	UNIT mm		A4	DWG NO. CN03958-7/3
					REVISION 5